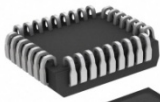
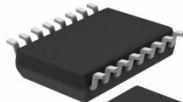


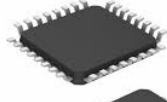
Device Package types



PLCC



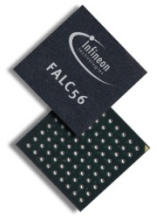
SOIC



TQFP / QFP



TSOP



BGA / FBGA



Die/Wafer
WL-CSP



3-SOT
(TT)
3 x 2.5 mm



8-TDFN
(MC/MNY)
2 x 3 mm



8-MSOP
(MS)
3 x 5 mm



8-TSSOP
(ST)
3 x 6.5 mm



8-SOIC (SN)
5 x 6 mm



8-PDIP (P)
8 x 9.5 mm

Low Cost
SOT-23



Standard
SOIC



Easy to Evaluate
PDIP



Small SMT
TSSOP



8-pin SOP



8-pin TSSOP



TMSOP-8



SNT-8A



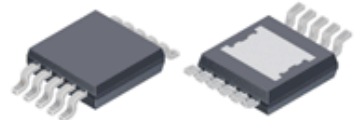
WLP

Packages

8-pin SOICN with
exposed thermal pad
(suffix LJ)



10-pin MSOP with
exposed thermal pad
(suffix LY)



16-pin TSSOP with
exposed thermal pad
(suffix LP)



Not to scale

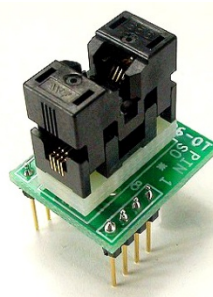
adapter types



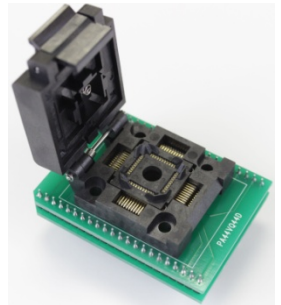
PLCC -LID



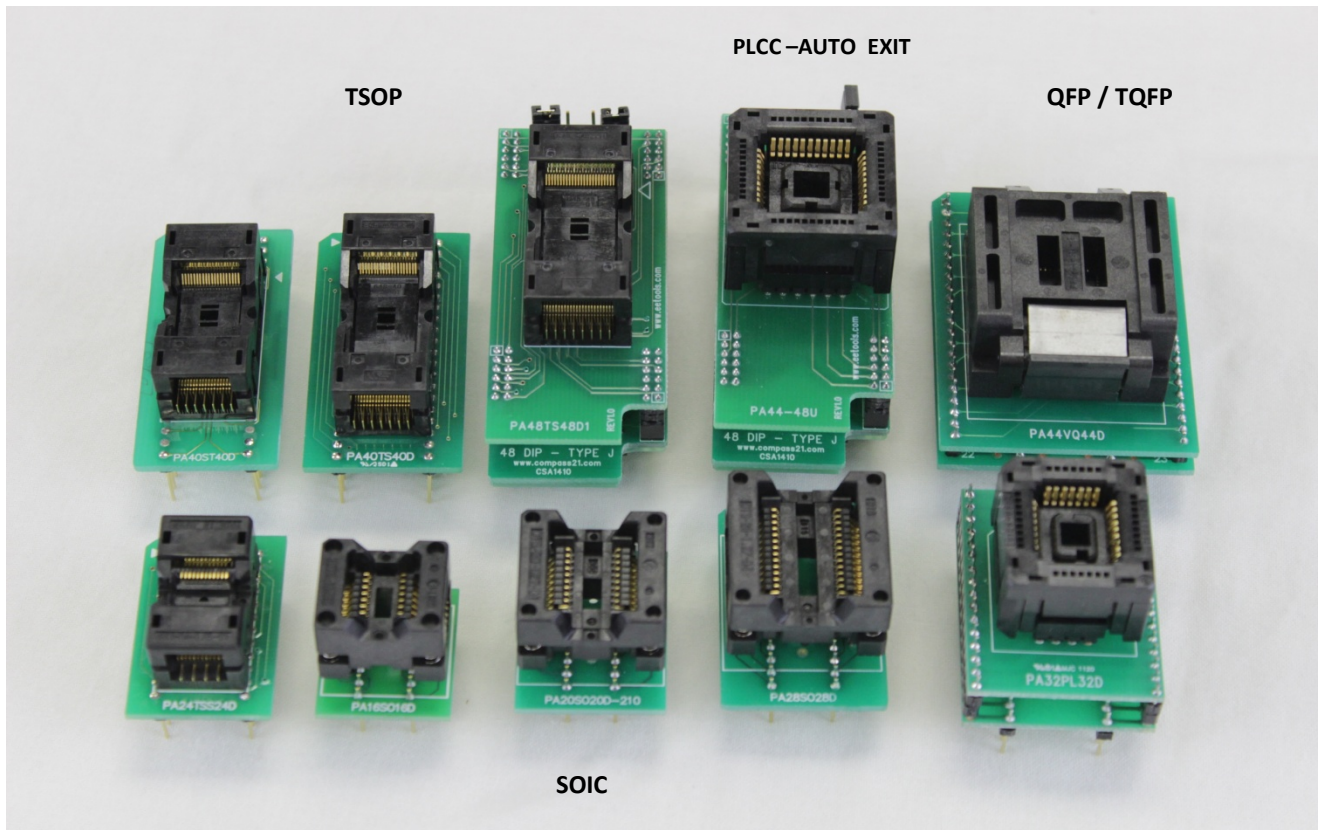
PLCC -AUTO EXIT



MSOP



QFP /TQFP



TSOP

PLCC-AUTO EXIT

QFP / TQFP

SOIC